

### 1.0X0.5X0.2mm (0402)SMD CHIP LED LAMP

Part Number: APG1005SEC/E-T

Hyper-Red

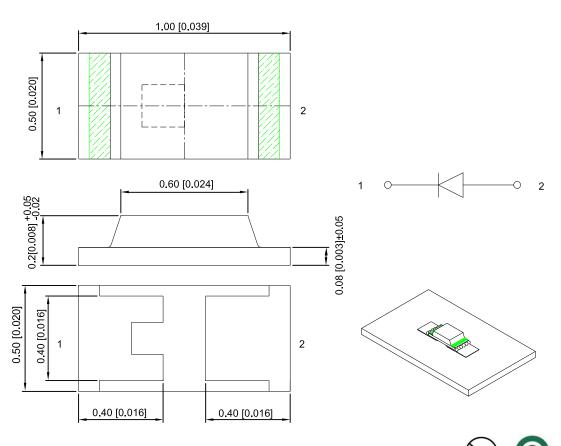
#### **Features**

- 1.0mmX0.5mm SMD LED, 0.2mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 4000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

The Hyper-Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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#### **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
ADC4005050/5 T	Hyper-Red (AlGalnP)	Mater Clear	55	127	- 120°
APG1005SEC/E-T		Water Clear	*20	*75	

#### Notes:

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
   Luminous intensity value is traceable to CIE127-2007 standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper-Red	632		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper-Red	624		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper-Red	20		nm	IF=20mA
VF [2]	Forward Voltage	Hyper-Red	2.0	2.4	V	IF=20mA
lr	Reverse Current	Hyper-Red		10	uA	V <sub>R</sub> =5V

### Notes:

- Wavelength: +/-1nm.
   Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

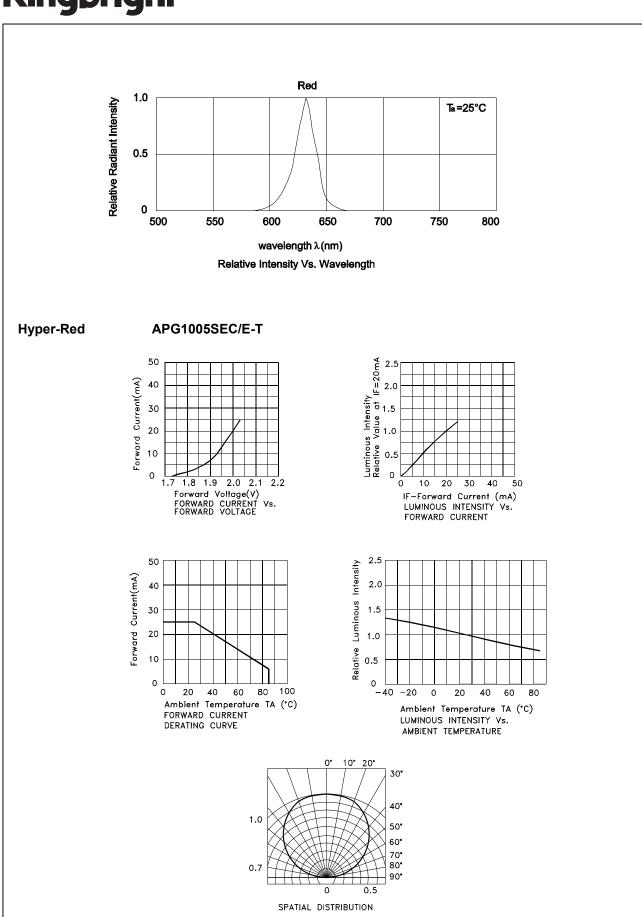
### Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units		
Power dissipation	wer dissipation 60			
DC Forward Current	25	mA		
Peak Forward Current [1]	120	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

### Notes:

- 1.1/10 Duty Cycle, 0.1ms Pulse Width.
   Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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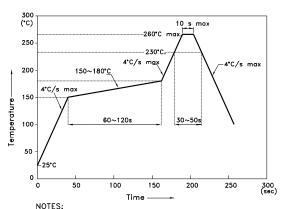


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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

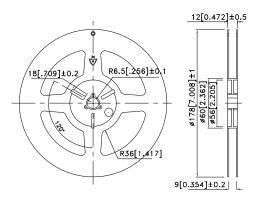
  3.Number of reflow process shall be 2 times or less.

## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

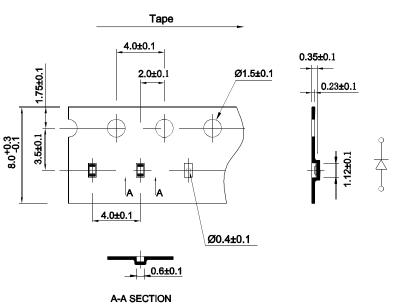
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Mask open area ratio:80% Mask thickness:80~100um

### **Reel Dimension**



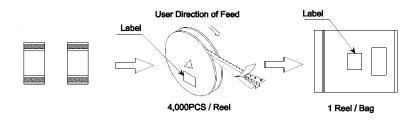
### Tape Dimensions (Units: mm)

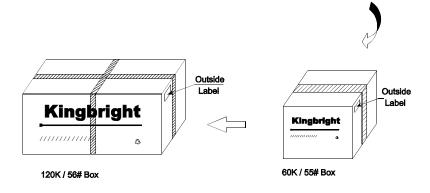


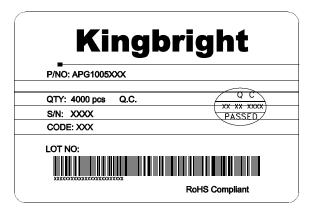
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### PACKING & LABEL SPECIFICATIONS

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